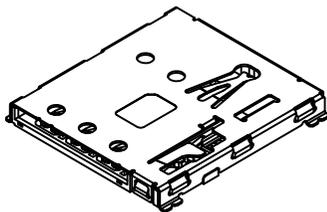


Recommended PCB Layout
General Tolerance±0.05

▨ PAD
▩ KEEP OUT AREA



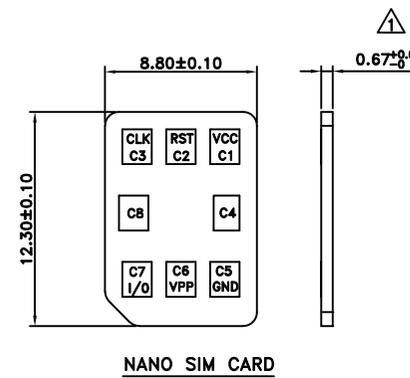
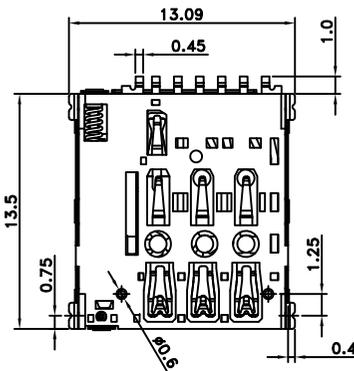
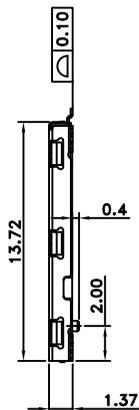
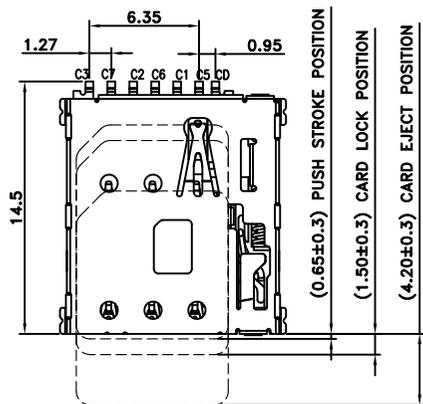
SIM Pin Assignment	
PIN#	Name
C1	VCC
C2	RST
C3	CLK
C5	GND
C6	VPP
C7	I/O

■ SPECIFICATIONS

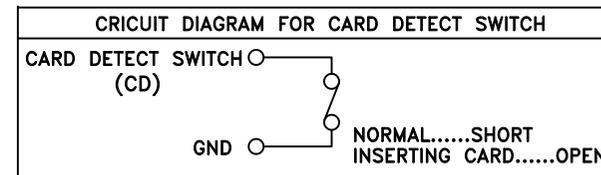
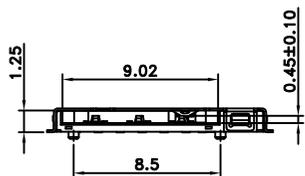
- Voltage Rating : 30 V AC
- Current Rating : 1.0 A
- Dielectric Withstanding Voltage: 500V AC.
- Insulation Resistance : 1000 MΩ min @ 500V DC
- Contact Resistance : 50 mΩ Max
- Solder ability: 260±0/-5°C, 30±10s.
- Durability: 5000 Cycles Min.
- Operating condition: Temperature-40°C~+85°C;
Humidity 80% R.H MAX

■ WAFER

- Part No. : GJS-NSIMBG2-07P
- Material : Contact : Cphosphor Copper · Contact Area:Gold Flash.
Solder Area: Gold Flash.Under Plate: Nickel.
Base&Slider : LCP UL 94V-0
Shell: Stanless Steel ,Nickel Plated
- Package : 1500Pcs/Reel



NANO SIM CARD



东莞乔唯电子有限公司
DONGGUAN CHYAO WEI
ELECTRONIC CO., LTD

APPROVED BY	SCALE	UNIT	TOLERANCE	LTR	REVISION RECORD	NAME	DATE	LTR	REVISION RECORD	NAME	DATE
張育瑞		mm	.0 ±0.30	1	修改SIM卡公差	曾庆根	2025. 5. 28	8			
CHECKED BY	PROJ	VER NO.	.00 ±0.20	2				9			
曾慶根		a1	.000 ±0.10	3				10			
DRAWN BY	DATE	SIZE	ANGLE	4					CUSTOMER		
曾慶根	2020/05/25	A4	0° ±1°	5					Conforms to The RoHS Instruction		
			.0° ±	6							
			SHEET 1/1	7							

PART NO GJS-NSIMBG2-07P

NANO SIM PUSH-PUSH 1.37H帶CD PIN 新款